

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20150316000 Datasheet update for ADS1282 Information Only

Date: 3/19/2015

To: Newark/Farnell PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team SC Business Services

20150316000 Information Only Datasheet Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE ADS1282IPW

CUSTOMER PART NUMBER

null

Technical details of this Product Change follow on the next page(s).

PCN	Number:		2015031	6000	n					ı	PCN Date:	03/19/201	
			pdate for ADS1282							_	OH Pate.	05/15/201	
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	Assembly Process			☐ Data Sheet					Wafer Bump Material				
	Assembly Materials				Part number change					Wafer Bump Process			
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Y	Texas Instruments	•											
www.t	i.com							SBAS4	181_SE	-рт	EMBER 2007-REVI	SED MARCH 2015	
												323 111 4 (31) 23 (3	
	Revision His												
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.													
Changes from Revision H (August 2013) to Revision I Page													
- D	Deleted low-power mode from data sheet, and made high-resolution mode default												
Changed MODE bit to 1 in register map after removing mode option													
Deleted MODE bit from CONFIGO; changed to						-							
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ADS	S1282HIPWR			ADS	DS1282IPWG4								

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com